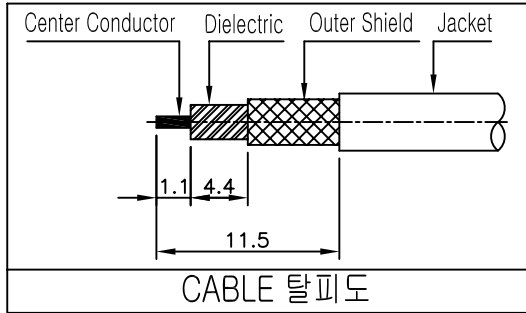
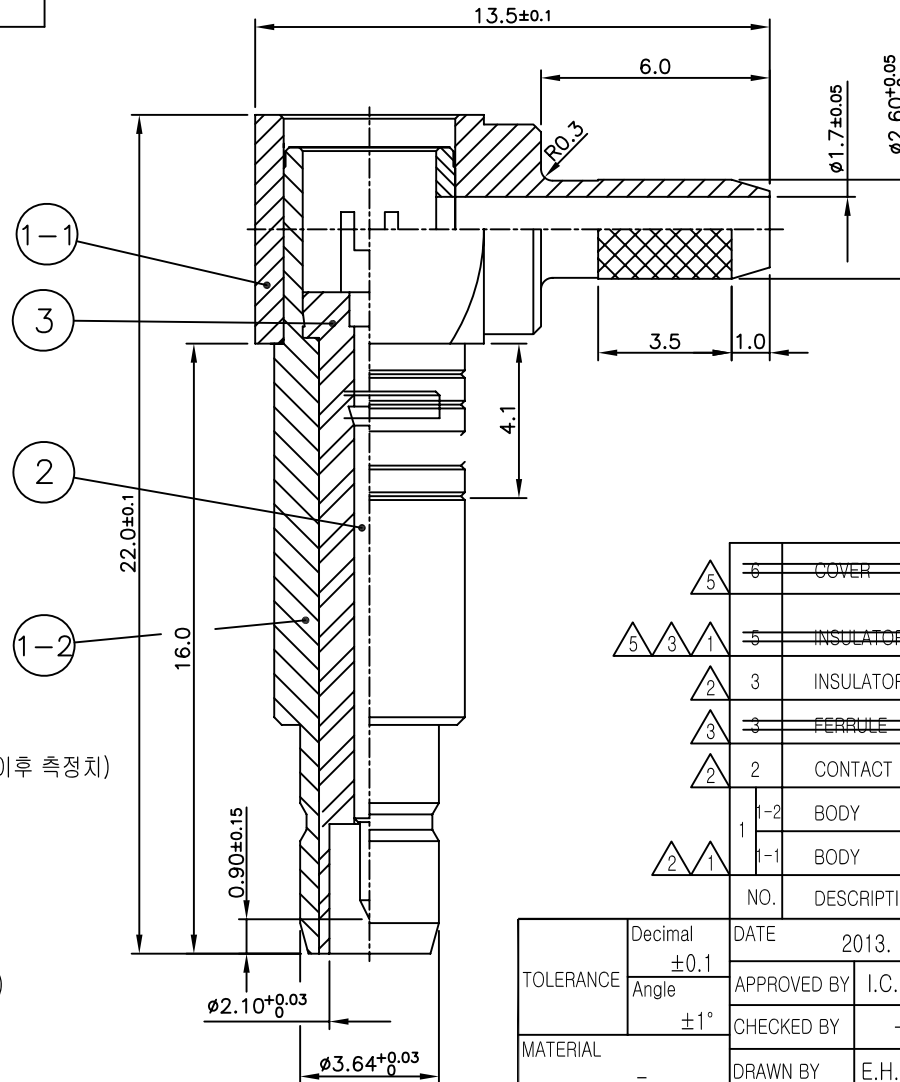




REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	E.H.KIM	S.J.YOUN	2006.05.10.
1	[설번No.200907-0001]업체요청 (1-1번 BODY 형상 및 6번 INSULATOR 변경)	E.H.KIM	J.H.YOUN	2009.07.07.
2	[설번No.200907-0016]신뢰성 향상 (특성 및 조립성 개선으로 인한 내부 구조 변경)	E.H.KIM	J.H.YOUN	2009.07.30.
3	[설번No.200912-0006]업체요청 (3 번 FERRULE 삭제)	E.H.KIM	J.H.YOUN	2009.12.08.
4	[설번No.201006-0013]공용화 (부품 공용화로 인한 INSULATOR 변경)	I.C.KIM	Y.H.CHOI	2010.06.16.
5	[설번No.201310-0011]업체요청 (COVER, INSULATOR 구성 삭제)	E.H.KIM	I.C.KIM	2013.10.22.



주 기

- 상대물과 삽입력과 이탈력 (상대물과 Mating 5회 이후 측정치)
 - 삽입력 : 2~4kgf
 - 이탈력 : 5~8kgf
- 상대물 Male Jack 내경 $\phi 3.44 \sim 3.45$ 관리
- 도금 사양
 - 내장용(실내)
 - Nickel Plate : $5\mu\text{m}$ 이상 (BODY, JACK, COVER)
 - Gold Plate : $0.4\mu\text{m}$ 이상 (CONTACT)

5	6	COVER	1	MBsBD C3604BD-F	Nickel Plate 5μm	DCO00020-5/1 (L3023)	
5 3 1	5	INSULATOR	1	PTFE	White	DIN00922-N/1 DIN01569-N/1 DIN00923-N/1 (H3144)	
2	3	INSULATOR	1	PTFE	White	DIN01617-N/1 DIN00989-N/1 (H3151)	
3	3	FERRULE	1	MBsBD C3604BD-F	Nickel Plate	DEF00034-5/1 (F3010)	
2	2	CONTACT	1	MBsBD C3604BD-F	Gold Plate 0.4μm	DCT02054-5/1 DCT01050-5/1 (E3169)	
1	1-2	BODY	1	MBsBD C3604BD-F	Nickel Plate 5μm	DBD01407-1/1 (D3176B)	
2 1	1-1	BODY	1	MBsBD C3604BD-F	Nickel Plate 5μm	DBB00237-5/1 DBB00082-5/1 DBD02518-3/1 DBD01406-3/1	
		NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2013. 10. 22.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL	-	CHECKED BY	-	TITLE SMB50 CABLE JL RG316(LONG) (SMB A/G MALE LONG)
		DRAWN BY	E.H.KIM	
FINISH	-	SCALE	5/1	DWG NO. CN01708-7/2 REVISION 5 SHEET 1 of 1
		UNIT	mm	